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September 2009

# SG6858 Low-Cost, Green-Mode, PWM Controller for Flyback Converters

#### **Features**

- Green-Mode PWM
- Supports the "Blue Angel" Standard
- Low Startup Current: 10µA (Maximum)
- Low Operating Current: 2.5mA
- Leading-Edge Blanking (LEB)
- Constant Output Power Limit
- Built-in Synchronized Slope Compensation
- Current-Mode Operation
- Cycle-by-Cycle Current Limiting
- Under-Voltage Lockout (UVLO)
- Programmable PWM Frequency
- V<sub>DD</sub> Over-Voltage Protection with Auto-Restart
- Gate Output Voltage Clamped at 17V
- Few External Components Required
- SSOT-26 and DIP-8 Packages Available

## **Applications**

- Battery chargers for cellular phones, cordless phones, PDAs, digital cameras, and power tools
- Power adapters for ink jet printers, video game consoles, and portable audio players
- Open-frame SMPS for TV/DVD standby and other auxiliary supplies, home appliances, PC 5V standby power, and consumer electronics
- Replacements for linear transformers and RCC SMPS
- Offline High Brightness (HB) LED drivers

## **Description**

This highly integrated PWM controller provides several special enhancements designed to meet the low standby-power needs of low-power SMPS. To minimize standby power consumption, the proprietary green-mode function provides off-time modulation to linearly decrease the switching frequency under light-load conditions. This green-mode function enables the power supply to meet even the strictest power conservation requirements.

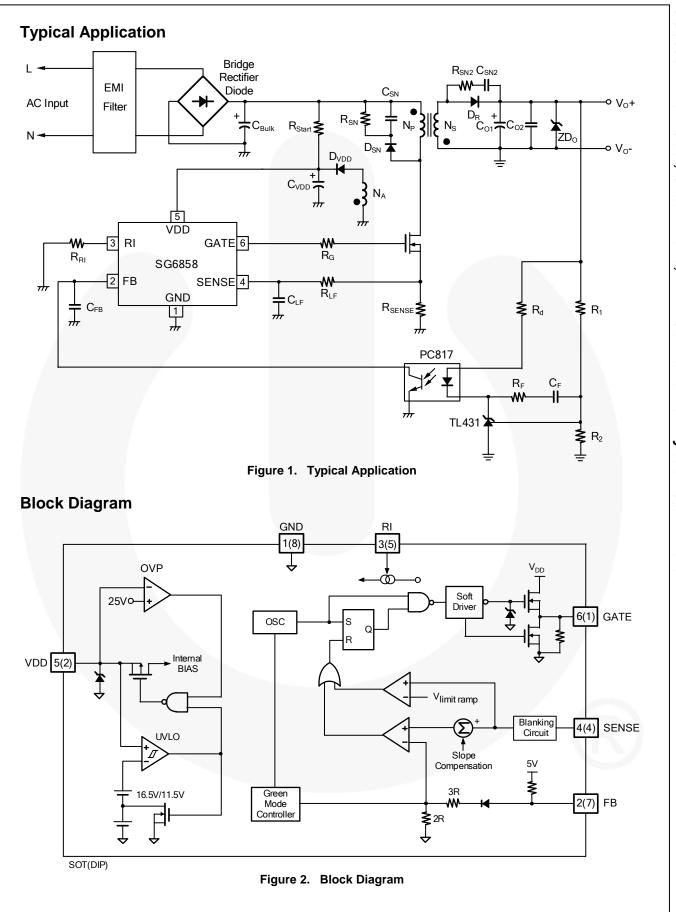
The BiCMOS fabrication process enables reducing the startup current to  $10\mu A$  and the operating current to 2.5mA. To further improve power conservation, a large startup resistance can be used. Built-in synchronized slope compensation ensures the stability of peak-current-mode control. Proprietary internal compensation provides a constant output power limit over a universal AC input range ( $90V_{AC}$  to  $264V_{AC}$ ). Pulse-by-pulse current limiting ensures safe operation even during short circuits.

To protect the external power MOSFET from being damaged by supply over voltage, the output driver is clamped at 17V. SG6858 controllers can improve the performance and reduce the production cost of power supplies. The SG6858 replaces linear and RCC-mode power adapters. It is available in 8-pin DIP and 6-pin SSOT-26 packages.

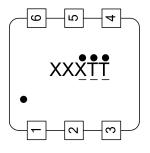
## **Ordering Information**

Part Number	Operating Temperature Range	<b>Eco Status</b>	Package	Packing Method	
SG6858TZ	-40 to +125°C	RoHS	6-Pin SSOT-26	Tape & Reel	
SG6858DZ	-40 to +125°C	RoHS	8-Pin DIP-8	Tube	

For Fairchild's definition of Eco Status, please visit: <a href="http://www.fairchildsemi.com/company/green/rohs\_green.html">http://www.fairchildsemi.com/company/green/rohs\_green.html</a>.



## **Marking Information**



XXX:AAI=SG6858 TT: Die run code

: Year code

- : Week code

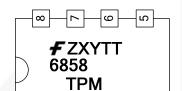


Figure 3. SSOT-26

F: Fairchild Logo

Z: Assembly Plant Code

X: Year Code

Y: Week Code

TT: Die Run Code

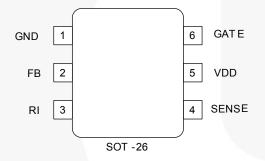
T: N=DIP

P: Y=Green Package

M: Manufacture flow code

Figure 4. DIP-8

## **Pin Configuration**



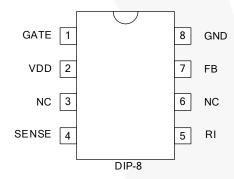


Figure 5. Pin Configurations

## **Pin Definitions**

Р	in #	Nama	Description
DIP-8	SSOT-26	Name	Description
1	6	GATE	Totem-pole output driver for the power MOSFET.
2	5	VDD	Power supply.
3		NC	No connection.
4	4	SENSE	Current sense. This pin senses the voltage across a resistor. When the voltage reaches the internal threshold, PWM output is disabled. This activates over-current protection. This pin provides current amplitude information for current-mode control.
5	3	RI	A resistor connected from the RI pin to ground generates a constant current source. This current is used to charge an internal capacitor to determine the switching frequency. Increasing the resistance reduces the amplitude of the current source and reduces the switching frequency. A $95k\Omega$ resistor, $R_{\text{I}}$ results in a $50\mu\text{A}$ constant current, $I_{\text{I}}$ and a $70k\text{Hz}$ switching frequency.
6		NC	No connection.
7	2	FB	Feedback. The FB pin provides the output voltage regulation signal, and feedback to the internal PWM comparator, so the PWM comparator can control the duty cycle.
8	1	GND	Ground.

## **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. All voltage values, except differential voltages, are given with respect to GND pin.

Symbol	Parameter			Min.	Max.	Unit
V <sub>DD</sub>	Supply Voltage				30	V
V <sub>FB</sub>	Input Voltage to FB Pin			-0.3	7.0	V
V <sub>SENSE</sub>	Input Voltage to SENSE Pin		-0.3	7.0	V	
Rejc	Thermal Resistance (Junction-to-Case)		SSOT		208.4	°C/W
I <b>V</b> ⊕JC	Thermal Resistance (Junction-to-Cas	DIP		82.5	C/ <b>VV</b>	
TJ	Operating Junction Temperature		-40	+125	°C	
T <sub>STG</sub>	Storage Temperature Range		-55	+150	°C	
TL	Lead Temperature, Wave Soldering, 10 Seconds			260	°C	
ESD	Electrostatic Discharge Capability	Human Bo	dy Model, JESD22-A114		3.0	kV
ESD	Machine		odel, JESD22-A115		0.2	NV

## **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
$V_{DD}$	DC Supply Voltage		22	V
T <sub>A</sub>	Operating Ambient Temperature	-40	+125	°C

## **Electrical Characteristics**

 $V_{DD}$ =15V,  $T_A$ =-40°C ~+125°C ( $T_A$ =  $T_J$ ), unless otherwise specified.

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
V <sub>DD</sub> Section	1					
V <sub>DD-OP</sub>	Continuously Operating Voltage				22	V
$V_{DD\text{-}ON}$	Turn-On Threshold Voltage		15.5	16.5	17.5	V
$V_{DD-OFF}$	Turn-Off Voltage		10.5	11.5	12.5	V
I <sub>DD-ST</sub>	Startup Current	$V_{DD}=V_{DD-ON}-0.1V$		10	15	μA
I <sub>DD-OP</sub>	Operating Supply Current	V <sub>DD</sub> =15V, GATE with 1nF to GND		2.5	3.5	mA
$V_{DD\text{-}OVP}$	V <sub>DD</sub> Over-Voltage Protection Level		23	25	26	V
t <sub>D-VDDOVP</sub>	V <sub>DD</sub> OVP Debounce Time		50	125	200	µsec
V <sub>DD-G OFF</sub>	V <sub>DD</sub> Low Threshold Voltage to Exit Green Off Mode		V <sub>DD-OFF</sub> + 0.95	V <sub>DD-OFF</sub> + 1.10	V <sub>DD-OFF</sub> + 1.25	V
Feedback I	nput Section					
Av	FB Input to Current Comparator Attenuation			2/5		V/V
Z <sub>FB</sub>	Input Impedance			5		kΩ
V <sub>FB-OPEN</sub>	FB Pin Open High Voltage		4.5	5.0	5.5	V
$V_{FB-N}$	Green Mode Entry FB Voltage			2.85		V
$V_{FB-G}$	Green Mode Ending FB Voltage			2.20		V
$S_{G}$	Green Mode Modulation Slope	R <sub>I</sub> =95kΩ		75		Hz/mV
Current Se	nse Section					
Z <sub>SENSE</sub>	Input Impedance		10			kΩ
t <sub>PD</sub>	Delay to Output			60	110	ns
V <sub>STHFL</sub>	Flat Threshold Voltage for Current Limit			0.96		V
V <sub>STHVA</sub>	Valley Threshold Voltage for Current Limit		0.75	0.80	0.85	V
t <sub>LEB</sub>	Leading-Edge Blanking Time		240	300	360	ns
DCY <sub>SAW</sub>	Duty Cycle of SAW Limit	Maximum Duty Cycle		45		%
Oscillator S	Section	•				
f <sub>OSC</sub>	Frequency	$R_i$ =95k $\Omega$	65	70	75	kHz
f <sub>OSC-G</sub>	Green Mode Frequency	R <sub>i</sub> =95kΩ		22		kHz
$f_{DV}$	Frequency Variation vs. V <sub>DD</sub> Deviation	V <sub>DD</sub> =13.5V to 22V	0	0.02	2.00	%
f <sub>DT</sub>	Frequency Variation vs. Temperature Deviation	T <sub>A</sub> =-40°C ~+125°C			2	%
Output Sec	tion				71	21
DCY <sub>MAX</sub>	Maximum Duty Cycle		70	75	80	%
V <sub>GATE-L</sub>	Output Voltage Low	V <sub>DD</sub> =15V, I <sub>O</sub> =20mA			1.5	V
V <sub>GATE-H</sub>	Output Voltage High	V <sub>DD</sub> =13.5V, I <sub>O</sub> =20mA	8			V
t <sub>R</sub>	Rising Time	V <sub>DD</sub> =13.5V, C <sub>L</sub> =1nF	100	170	240	ns
t <sub>F</sub>	Falling Time	V <sub>DD</sub> =13.5V, C <sub>L</sub> =1nF	35	55	75	ns
V <sub>GATE-CLAMP</sub>	Output Clamp Voltage	V <sub>DD</sub> =13.5V, T <sub>A</sub> =25°C	16	17	18	V

## **Typical Performance Characteristics**

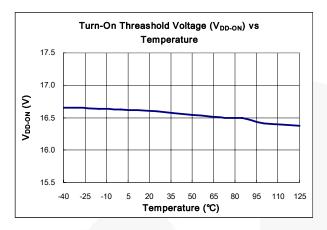


Figure 6. Turn-On Threshold Voltage ( $V_{DD-ON}$ ) vs. Temperature

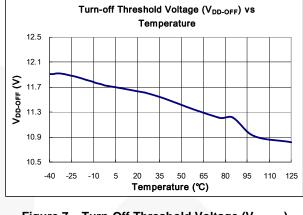


Figure 7. Turn-Off Threshold Voltage (V<sub>DD-OFF</sub>) vs. Temperature

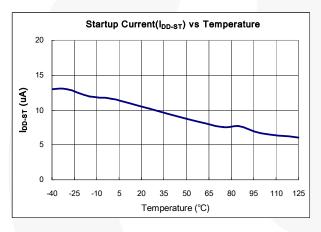


Figure 8. Startup Current (IDD-ST) vs. Temperature

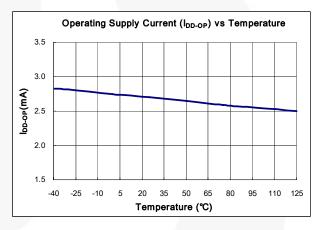


Figure 9. Operating Supply Current (I<sub>DD-OP</sub>) vs. Temperature

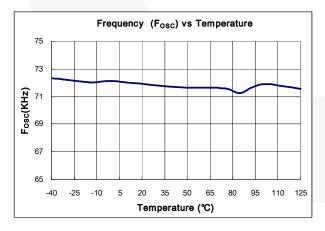


Figure 10. Frequency (fosc) vs. Temperature

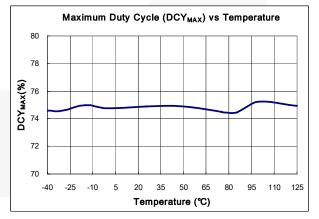


Figure 11. Maximum Duty Cycle (DCY<sub>MAX</sub>) vs. Temperature

## **Typical Performance Characteristics** (Continued)

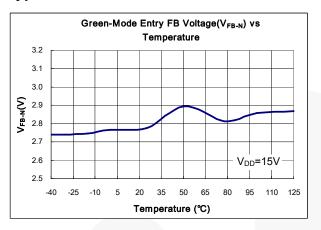


Figure 12. Green Mode Entry FB Voltage (V<sub>FB-N</sub>) vs. Temperature

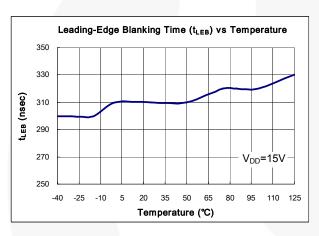


Figure 14. Leading-Edge Blanking Time (t<sub>LEB</sub>) vs. Temperature

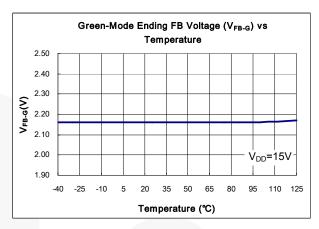


Figure 13. Green Mode Ending FB Voltage (V<sub>FB-G</sub>) vs. Temperature

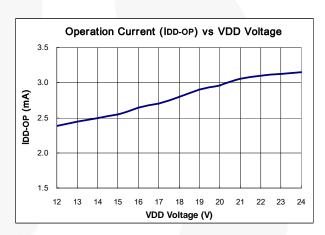


Figure 15. Operating Current (I<sub>DD-OP</sub>) vs. Temperature

## **Operation Description**

SG6858 devices integrate many useful designs into one controller for low-power switch-mode power supplies. The following descriptions highlight some of the features of the SG6858 series.

#### **Startup Operation**

The startup current is only 10 $\mu$ A. Low startup current allows a startup resistor with a high resistance and low wattage to supply the startup power for the controller. A 1.5M $\Omega$ , 0.25W, startup resistor and a 10 $\mu$ F/25V V<sub>DD</sub> hold-up capacitor would be sufficient for an AC-to-DC power adapter with a wide input range (100V<sub>AC</sub> to 240V<sub>AC</sub>).

#### **Operating Current**

The operating current has been reduced to 2.5mA. The low operating current results in higher efficiency and reduces the  $V_{\text{DD}}$  hold-up capacitance requirement.

#### **Green-Mode Operation**

The proprietary green-mode function provides off-time modulation to linearly decrease the switching frequency under light-load conditions. On-time is limited to provide stronger protection against brownouts and other abnormal conditions. The feedback current, which is sampled from the voltage feedback loop, is taken as the reference. Once the feedback current exceeds the threshold current, the switching frequency starts to decrease. This green-mode function dramatically reduces power consumption under light-load and zero-load conditions. Power supplies using the SG6858 meet the strictest regulations regarding standby power consumption.

#### **Oscillator Operation**

A resistor connected from the RI pin to ground generates a constant current source for the SG6858. This current is used to charge an internal capacitor. The charge-time determines the internal clock speed and the switching frequency. Increasing the resistance reduces the amplitude of the input current and reduces the switching frequency. A 95k $\Omega$  resistor  $R_{\rm I}$  results in a 50 $\mu$ A constant current  $I_{\rm I}$  and a 70kHz switching frequency. The relationship between  $R_{\rm I}$  and the switching frequency is:

$$f_{\text{PWM}} = \frac{6650}{\text{RI} (k\Omega)} (kHz) \tag{1}$$

## Leading-Edge Blanking (LEB)

Each time the power MOSFET is switched on, a turn-on spike occurs at the sense-resistor. To avoid premature termination of the switching pulse, a 300ns leading-edge blanking time is built in. Conventional RC filtering can therefore be omitted. During this blanking period, the current-limit comparator is disabled and it cannot switch off the gate driver.

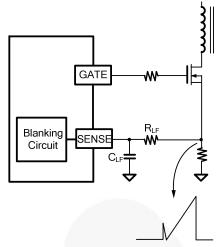


Figure 16. Current Sense R-C Filter

#### **Constant Output Power Limit**

When the SENSE voltage across the sense resistor  $R_S$  reaches the threshold voltage (around 0.96V), the output GATE drive is turned off following a short propagation delay  $t_{PD}$ .

This propagation delay introduces an additional current proportional to  $t_{\rm PD} \cdot V_{\rm IN}/L_{\rm P.}$  The propagation delay is nearly constant regardless of the input line voltage  $V_{\rm IN}.$  Higher input line voltages result in larger additional currents. At high input line voltages, the output power limit is higher than at low input line voltages.

To compensate for this output power limit variation across a wide AC input range, the threshold voltage is adjusted by adding a positive ramp ( $V_{LIMIT\_RAMP}$ ).

This ramp signal rises from 0.80V to 0.96V, then flattens out at 0.96V. A smaller threshold voltage forces the output GATE drive to terminate earlier. This reduces the total PWM turn-on time and makes the output power equal to that of low line input. This proprietary internal compensation ensures a constant output power limit for a wide AC input voltage range (90V<sub>AC</sub> to 264V<sub>AC</sub>).

#### **Under-Voltage Lockout (UVLO)**

The turn-on and turn-off thresholds are fixed internally at 16.5V/11.5V. During startup, the hold-up capacitor must be charged to 16.5V through the startup resistor, so that the SG6858 is enabled. The hold-up capacitor continues to supply  $V_{DD}$  until power can be delivered from the auxiliary winding of the main transformer.  $V_{DD}$  must not drop below 11.5V during this startup process. This UVLO hysteresis window ensures that the hold-up capacitor is adequate to supply  $V_{DD}$  during startup.

## **V<sub>DD</sub> Over-Voltage Protection (OVP)**

Integrated  $V_{DD}$  over-voltage protection prevents damage due to over-voltage conditions. When the  $V_{DD}$  exceeds the internal threshold due to abnormal conditions, PWM output is turned off until the  $V_{DD}$  voltage drops below the UVLO, then starts again. Over-voltage conditions are usually caused by open feedback loops.

#### **Gate Output**

The BiCMOS output stage is a fast totem-pole gate driver. Cross conduction has been avoided to minimize heat dissipation, increase efficiency, and enhance reliability. The output driver is clamped by an internal 17V Zener diode to protect power MOSFET transistors against undesired over-voltage gate signals.

#### **Built-in Slope Compensation**

The sensed voltage across the current sense resistor is used for current mode control and pulse-by-pulse current limiting. Built-in slope compensation improves stability and prevents sub-harmonic oscillations due to peak-current mode control. The SG6858 has a synchronized, positively-sloped ramp built-in at each switching cycle. The slope of the ramp is:

$$\frac{0.36 \times Duty}{Duty(\text{max.})} \tag{2}$$

#### **Noise Immunity**

Noise from the current sense or the control signal can cause significant pulsewidth jitter, particularly in continuous-conduction mode. While slope compensation helps alleviate this problem, further precautions should be taken. Good placement and layout practices should be followed. Avoiding long PCB traces and component leads, locating compensation and filter components near the SG6858, and increasing the power MOS gate resistance are advised.

## **Typical Application Circuit (Flyback Converter for Printer Application)**

Application	Fairchild Devices	Input Voltage Range	Output	
Adapter	SG6858	90~264V <sub>AC</sub>	12V/1.25A (15W)	

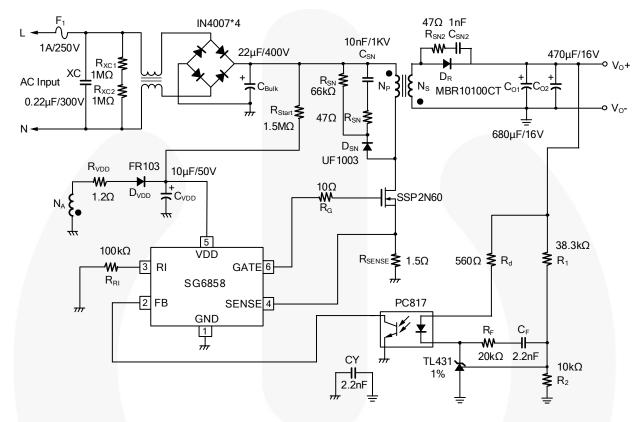


Figure 17. Schematic of Application Circuit

## **Transformer**

- Core: EF-20
- Primary-Side Inductance: 2mH (Pin1 to Pin3)

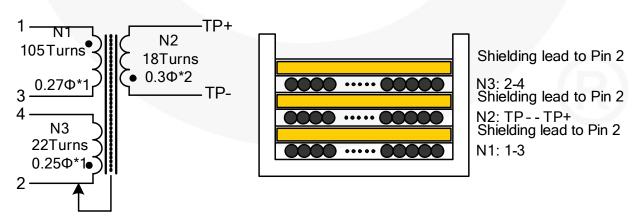


Figure 18. Transformer Structure

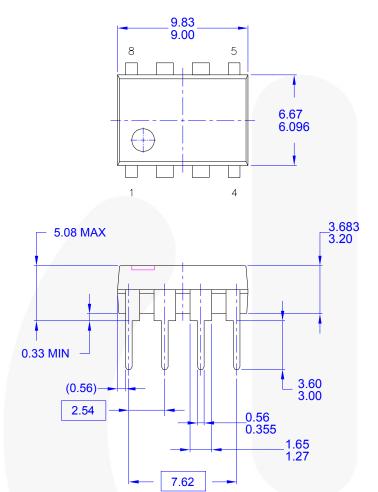
## **Physical Dimensions SYMM** q 0.95 0.95 3.00 2.80 A 1,00 6 В 3.00 2.60 2.60 1,70 1,50 0.50 0.95 0.70 MIN -0.20M A B .90 LAND PATTERN RECOMMENDATION (0.30) -SEE DETAIL A -1,10 MAX 1,00 0,70 0.20 0.08 С 0.10 O.10 C NOTES: UNLESS OTHERWISE SPECIFIED GAGE PLANE THIS PACKAGE CONFORMS TO JEDEC MO-193. VAR. AA, ISSUE C, DATED JANUARY 2000. ALL DIMENSIONS ARE IN MILLIMETERS. 0.25 0.55 0.35 SEATING PLANE -0.60 REF DETAIL A MAG6AREVD

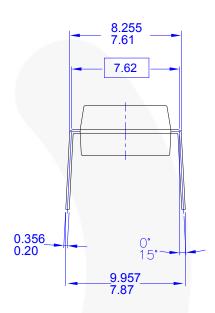
Figure 19. 6-Pin, SSOT-6 Package

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## Physical Dimensions (Continued)





NOTES: UNLESS OTHERWISE SPECIFIED

- A) THIS PACKAGE CONFORMS TO JEDEC MS-001 VARIATION BA
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D) DIMENSIONS AND TOLERANCES PER ASME Y14.5M-1994
- E) DRAWING FILENAME AND REVSION: MKT-N08FREV2.

Figure 20. 8-Pin, Dual-Inline Package (DIP-8)

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#### Definition of Terms

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